IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hiroyuki KANBARA et al.	
Application No.: 10/596,000	Art Unit: 1795
Confirmation No.: 1561	
Filing or 371(c) Date: January 17, 2007	Examiner: A. Eoff
Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT, AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	
AMENDMENT	

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated June 22, 2010, the period for response to
which has been extended to November 22, 2010, by the accompanying Petition for
Two-Month Extension of Time, please amend the above-identified application as
follows:
Amendments to the Specification begin on page of this paper.
Amendments to the Claims are reflected in the listing of the claims which
begins on page 2 of this paper.
☐ Amendments to the Drawings begin on page of this paper and include an
attached replacement sheet. An Appendix including the amended drawing figures is
attached following page of this paper.
Remarks/Arguments begin on page 7 of this paper.
Please note, if a box is not checked, then no corresponding amendment is being made.